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# 74AUP1G58

## TinyLogic® Low Power Universal Configurable Two-Input Logic Gate

### Features

- 0.8V to 3.6V  $V_{CC}$  Supply Operation
- 3.6V Over-Voltage Tolerant I/Os at  $V_{CC}$  from 0.8V to 3.6V
- High Speed  $t_{PD}$ 
  - 3.1ns: Typical at 3.3V
- Power-Off High-Impedance Inputs and Outputs
- Low Static Power Consumption
  - $I_{CC}$ =0.9 $\mu$ A Maximum
- Low Dynamic Power Consumption
  - $C_{PD}$ =2.9pF Typical at 3.3V
- Ultra-Small MicroPak™ Packages

### Description

The 74AUP1G58 is a universal configurable 2-input logic gate that provides a high performance and low power solution ideal for battery-powered portable applications. This product is designed for a wide low voltage operating range (0.8V to 3.6V) and guarantees very low static and dynamic power consumption across the entire voltage range. All inputs are implemented with hysteresis to allow for slower transition input signals and better switching noise immunity.

The 74AUP1G58 provides for multiple functions as determined by various configurations of the three inputs. The potential logic functions provided are AND, OR, NOR, NAND, and XNOR, inverter and non-inverter. Refer to Figures 2 to 8.

### Ordering Information

Part Number	Top Mark	Package	Packing Method
74AUP1G58L6X	AC	6-Lead MicroPak™, 1.0mm Wide	5000 Units on Tape & Reel
74AUP1G58FHX	AC	6-Lead, MicroPak2™, 1x1mm Body, .35mm Pitch	5000 Units on Tape & Reel

## Pin Configurations

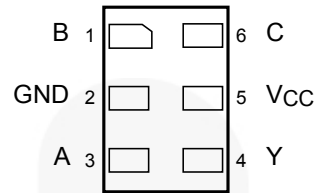


Figure 1. MicroPak™ (Top Through View)

## Pin Definitions

Pin #	Name	Description
1	B	Data Input
2	GND	Ground
3	A	Data Input
4	Y	Output
5	V <sub>CC</sub>	Supply Voltage
6	C	Data Input

## Function Table

Inputs			74AUP1G58
C	B	A	Y=Output
L	L	L	L
L	L	H	H
L	H	L	L
L	H	H	H
H	L	L	H
H	L	H	H
H	H	L	L
H	H	H	L

H = HIGH Logic Level

L = LOW Logic Level

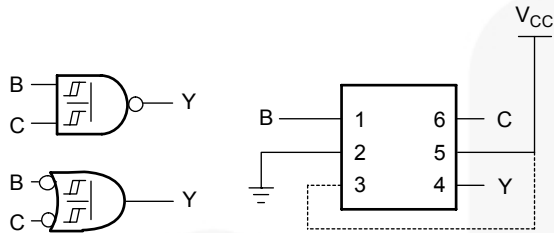
## Function Selection Table

2-Input Logic Function	Connection Configuration
2-Input AND with Inverted Input	Figure 3, Figure 4
2-Input NAND	Figure 2
2-Input NAND with Both Inputs Inverted	Figure 5
2-Input OR	Figure 5
2-Input OR with Both Inputs Inverted	Figure 2
2-Input NOR with Inverted Inputs	Figure 3, Figure 4
2-Input XOR	Figure 6
Inverter	Figure 7
Buffer	Figure 8

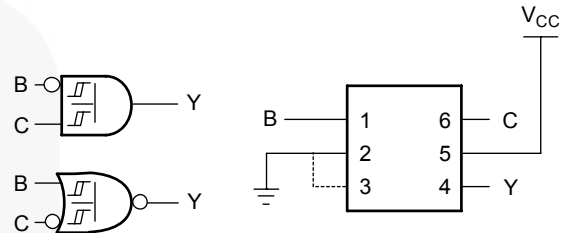
## 74AUP1G58 Logic Configurations

Figure 2 through Figure 8 show the logical functions that can be implemented using the 74AUP1G58. The diagrams show the DeMorgan's equivalent logic duals for a given two-input function. The logical

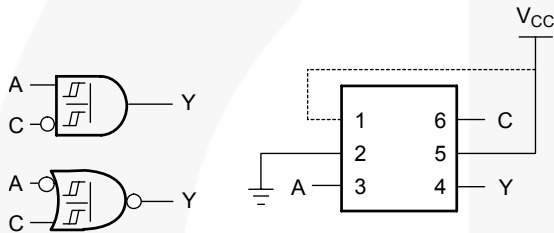
implementation is next to the board-level physical implementation of how the pins of the function should be connected.



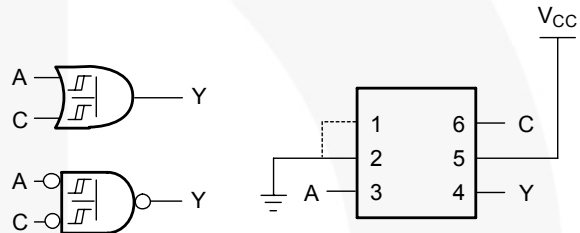
**Figure 2. 2-Input NAND Gate or 2-Input OR with Both Inputs Inverted**



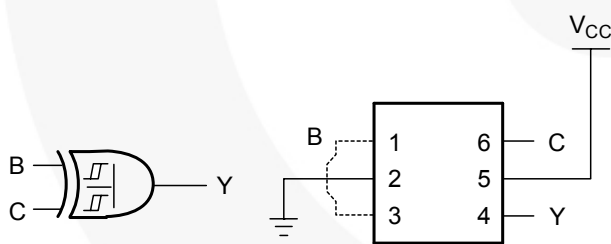
**Figure 3. 2-Input AND with Inverted B Input or 2-Input NOR Gate with Inverted C Input**



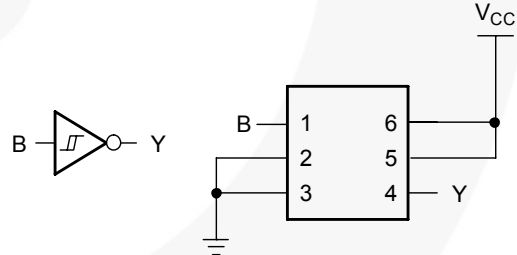
**Figure 4. 2-Input AND with Inverted C Input or 2-Input NOR Gate with Inverted A Input**



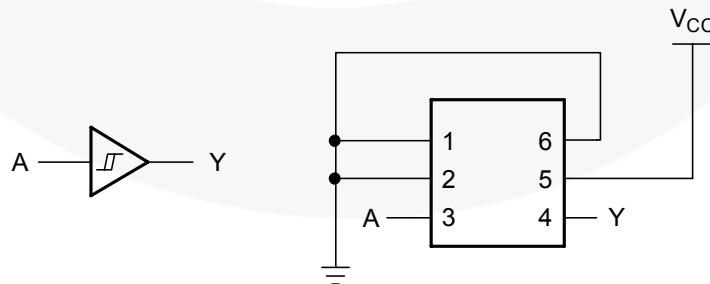
**Figure 5. 2-Input OR Gate or 2-Input NAND Gate with Both Inputs Inverted**



**Figure 6. 2-Input XOR Gate**



**Figure 7. Inverter**



**Figure 8. Buffer**

## Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Min.	Max.	Unit
$V_{CC}$	Supply Voltage	-0.5	4.6	V
$V_{IN}$	DC Input Voltage	-0.5	4.6	V
$V_{OUT}$	DC Output Voltage	HIGH or LOW State <sup>(1)</sup>	$V_{CC} + 0.5$	V
		$V_{CC}=0V$	4.6	
$I_{IK}$	DC Input Diode Current	$V_{IN} < 0V$	-50	mA
$I_{OK}$	DC Output Diode Current	$V_{OUT} < 0V$	-50	mA
		$V_{OUT} > V_{CC}$	+50	
$I_{OH} / I_{OL}$	DC Output Source / Sink Current		±50	mA
$I_{CC}$ or $I_{GND}$	DC $V_{CC}$ or Ground Current per Supply Pin		±50	mA
$T_{STG}$	Storage Temperature Range	-65	+150	°C
$T_J$	Junction Temperature Under Bias		+150	°C
$T_L$	Junction Lead Temperature, Soldering 10s		+260	°C
$P_D$	Power Dissipation at +85°C	MicroPak-6	130	mW
		MicroPak2-6	120	
ESD	Human Body Model, JEDEC:JESD22-A114		5000+	V
	Charged Device Model, JEDEC:JESD22-C101		2000	

### Note:

- $I_O$  absolute maximum rating must be observed.

## Recommended Operating Conditions<sup>(2)</sup>

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameter	Conditions	Min.	Max.	Unit
$V_{CC}$	Supply Voltage		0.8	3.6	V
$V_{IN}$	Input Voltage		0	3.6	V
$V_{OUT}$	Output Voltage	$V_{CC}=0V$	0	3.6	V
		HIGH or LOW State	0	$V_{CC}$	
$I_{OH}/I_{OL}$	Output Current	$V_{CC}=3.0V$ to 3.6V		±4.0	mA
		$V_{CC}=2.3V$ to 2.7V		±3.1	
		$V_{CC}=1.65V$ to 1.95V		±1.9	
		$V_{CC}=1.4V$ to 1.6V		±1.7	
		$V_{CC}=1.1V$ to 1.3V		±1.1	
		$V_{CC}=0.8V$		±20.0	µA
$T_A$	Operating Temperature, Free Air		-40	+85	°C
$\theta_{JA}$	Thermal Resistance	MicroPak-6		500	°C/W
		MicroPak2-6		560	

### Note:

- Unused inputs must be held HIGH or LOW. They may not float.

### DC Electrical Characteristics

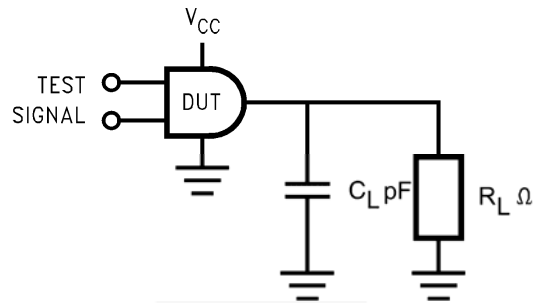
Symbol	Parameter	V <sub>CC</sub>	Conditions	T <sub>A</sub> =+25°C		T <sub>A</sub> =-40 to +85°C		Units
				Min.	Max.	Min.	Max.	
V <sub>P</sub>	Positive Threshold Voltage	0.80		0.30	0.60	0.30	0.60	V
		1.10		0.53	0.90	0.53	0.90	
		1.40		0.74	1.11	0.74	1.11	
		1.65		0.91	1.29	0.91	1.29	
		2.30		1.37	1.77	1.37	1.77	
		3.00		1.88	2.29	1.88	2.29	
V <sub>N</sub>	Negative Threshold Voltage	0.80		0.10	0.60	0.10	0.60	V
		1.10		0.26	0.65	0.26	0.65	
		1.40		0.39	0.75	0.39	0.75	
		1.65		0.47	0.84	0.47	0.84	
		2.30		0.69	1.04	0.69	1.04	
		3.00		0.88	1.24	0.88	1.24	
V <sub>H</sub>	Hysteresis Voltage	0.80		0.07	0.50	0.07	0.50	V
		1.10		0.08	0.46	0.08	0.46	
		1.40		0.18	0.56	0.18	0.56	
		1.65		0.27	0.66	0.27	0.66	
		2.30		0.53	0.92	0.53	0.92	
		3.00		0.79	1.31	0.79	1.31	
V <sub>OH</sub>	HIGH Level Output Voltage	0.80 ≤ V <sub>CC</sub> ≤ 3.60	I <sub>OH</sub> =-20μA	V <sub>CC</sub> -0.1		V <sub>CC</sub> -0.1		V
		1.10 ≤ V <sub>CC</sub> ≤ 1.30	I <sub>OH</sub> =-1.1mA	0.75 x V <sub>CC</sub>		0.70 x V <sub>CC</sub>		
		1.40 ≤ V <sub>CC</sub> ≤ 1.60	I <sub>OH</sub> =-1.7mA	1.11		1.03		
		1.65 ≤ V <sub>CC</sub> ≤ 1.95	I <sub>OH</sub> =-1.9mA	1.32		1.30		
		2.30 ≤ V <sub>CC</sub> ≤ 2.70	I <sub>OH</sub> =-2.3mA	2.05		1.97		
			I <sub>OH</sub> =-3.1mA	1.90		1.85		
		3.00 ≤ V <sub>CC</sub> ≤ 3.60	I <sub>OH</sub> =-2.7mA	2.72		2.67		
			I <sub>OH</sub> =-4.0mA	2.60		2.55		
V <sub>OL</sub>	LOW Level Output Voltage	0.80 ≤ V <sub>CC</sub> ≤ 3.60	I <sub>OL</sub> =20μA		0.10		0.10	V
		1.10 ≤ V <sub>CC</sub> ≤ 1.30	I <sub>OL</sub> =1.1mA		0.30 x V <sub>CC</sub>		0.30 x V <sub>CC</sub>	
		1.40 ≤ V <sub>CC</sub> ≤ 1.60	I <sub>OL</sub> =1.7mA		0.31		0.37	
		1.65 ≤ V <sub>CC</sub> ≤ 1.95	I <sub>OL</sub> =1.9mA		0.31		0.35	
		2.30 ≤ V <sub>CC</sub> ≤ 2.70	I <sub>OL</sub> =2.3mA		0.31		0.33	
			I <sub>OL</sub> =3.1mA		0.44		0.45	
		2.70 ≤ V <sub>CC</sub> ≤ 3.60	I <sub>OL</sub> =2.7mA		0.31		0.33	
			I <sub>OL</sub> =4.0mA		0.44		0.45	
I <sub>IN</sub>	Input Leakage Current	0V to 3.6V	0 ≤ V <sub>IN</sub> ≤ 3.6		±0.1		±0.5	μA
I <sub>OFF</sub>	Power Off Leakage Current	0V	0 ≤ (V <sub>IN</sub> , V <sub>O</sub> ) ≤ 3.6		0.2		0.6	μA
ΔI <sub>OFF</sub>	Additional Power Off Leakage Current	0V to 0.2V	V <sub>IN</sub> or V <sub>O</sub> = 0V to 3.6V		0.2		0.6	μA
I <sub>CC</sub>	Quiescent Supply Current	0.8V to 3.6V	V <sub>IN</sub> - V <sub>CC</sub> or GND		0.5		0.9	μA
			V <sub>CC</sub> ≤ V <sub>IN</sub> ≤ 3.6				±0.9	
ΔI <sub>CC</sub>	Increase in I <sub>CC</sub> per Input	3.3V	V <sub>IN</sub> = V <sub>CC</sub> -0.6V		40.0		50.0	μA

### AC Electrical Characteristics

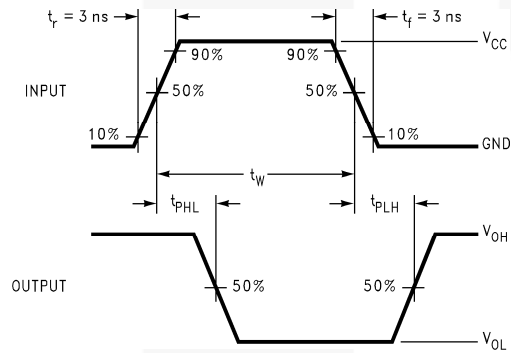
Symbol	Parameter	V <sub>CC</sub>	Conditions	T <sub>A</sub> =+25°C			T <sub>A</sub> =-40 to +85°C		Units	Figure	
				Min.	Typ.	Max	Min	Max			
t <sub>PHL</sub> , t <sub>PLH</sub>	Propagation Delay	0.80	C <sub>L</sub> =5pF, R <sub>L</sub> =1MΩ		22.8				ns	Figure 9 Figure 10	
		1.10 ≤ V <sub>CC</sub> ≤ 1.30		2.8	8.9	12.9	2.6	13.1			
		1.40 ≤ V <sub>CC</sub> ≤ 1.60		2.4	5.2	7.9	2.4	8.6			
		1.65 ≤ V <sub>CC</sub> ≤ 1.95		2.0	4.4	6.5	2.0	7.2			
		2.30 ≤ V <sub>CC</sub> ≤ 2.70		1.7	3.6	4.9	1.8	5.2			
		3.00 ≤ V <sub>CC</sub> ≤ 3.60		1.3	3.1	4.2	1.6	4.7			
		0.80	C <sub>L</sub> =10pF, R <sub>L</sub> =1MΩ		26.4						
		1.10 ≤ V <sub>CC</sub> ≤ 1.30		3.2	7.4	14.5	3.0	14.9			
		1.40 ≤ V <sub>CC</sub> ≤ 1.60		2.7	5.4	8.7	2.7	9.4			
		1.65 ≤ V <sub>CC</sub> ≤ 1.95		2.3	4.5	7.1	2.3	7.9			
		2.30 ≤ V <sub>CC</sub> ≤ 2.70		1.9	3.8	5.3	1.9	5.9			
		3.00 ≤ V <sub>CC</sub> ≤ 3.60	1.3	3.5	4.6	1.3	4.9				
		0.80	C <sub>L</sub> =15pF, R <sub>L</sub> =1MΩ		29.9						
		1.10 ≤ V <sub>CC</sub> ≤ 1.30		3.6	9.9	16.1	3.3	16.7			
		1.40 ≤ V <sub>CC</sub> ≤ 1.60		3.0	6.5	9.7	3.0	10.5			
		1.65 ≤ V <sub>CC</sub> ≤ 1.95		2.8	5.2	7.9	2.5	8.7			
		2.30 ≤ V <sub>CC</sub> ≤ 2.70		2.3	4.1	5.9	2.3	6.6			
		3.00 ≤ V <sub>CC</sub> ≤ 3.60	1.3	3.5	5.2	1.3	5.5				
		0.80	C <sub>L</sub> =30pF, R <sub>L</sub> =1MΩ		28.8			31.4			
		1.10 ≤ V <sub>CC</sub> ≤ 1.30		3.4	9.1	18.5	3.4	19.0			
1.40 ≤ V <sub>CC</sub> ≤ 1.60	3.1	5.5		10.5	3.1	11.0					
1.65 ≤ V <sub>CC</sub> ≤ 1.95	2.1	4.4		8.7	2.1	9.5					
2.30 ≤ V <sub>CC</sub> ≤ 2.70	1.7	3.6		6.5	1.7	7.1					
3.00 ≤ V <sub>CC</sub> ≤ 3.60	1.3	3.1	5.6	1.3	6.3						
C <sub>IN</sub>	Input Capacitance	0		0.8				pF			
C <sub>OUT</sub>	Output Capacitance	0		1.7				pF			
C <sub>PD</sub>	Power Dissipation Capacitance	0.80	V <sub>IN</sub> =0V or V <sub>CC</sub> , f=10MHz		1.8				pF		
		1.10 ≤ V <sub>CC</sub> ≤ 1.30			1.82						
		1.40 ≤ V <sub>CC</sub> ≤ 1.60			1.85						
		1.65 ≤ V <sub>CC</sub> ≤ 1.95			1.9						
		2.30 ≤ V <sub>CC</sub> ≤ 2.70			2.1						
		3.00 ≤ V <sub>CC</sub> ≤ 3.60			2.9						



## AC Loadings and Waveforms



**Figure 9. AC Test Circuit**

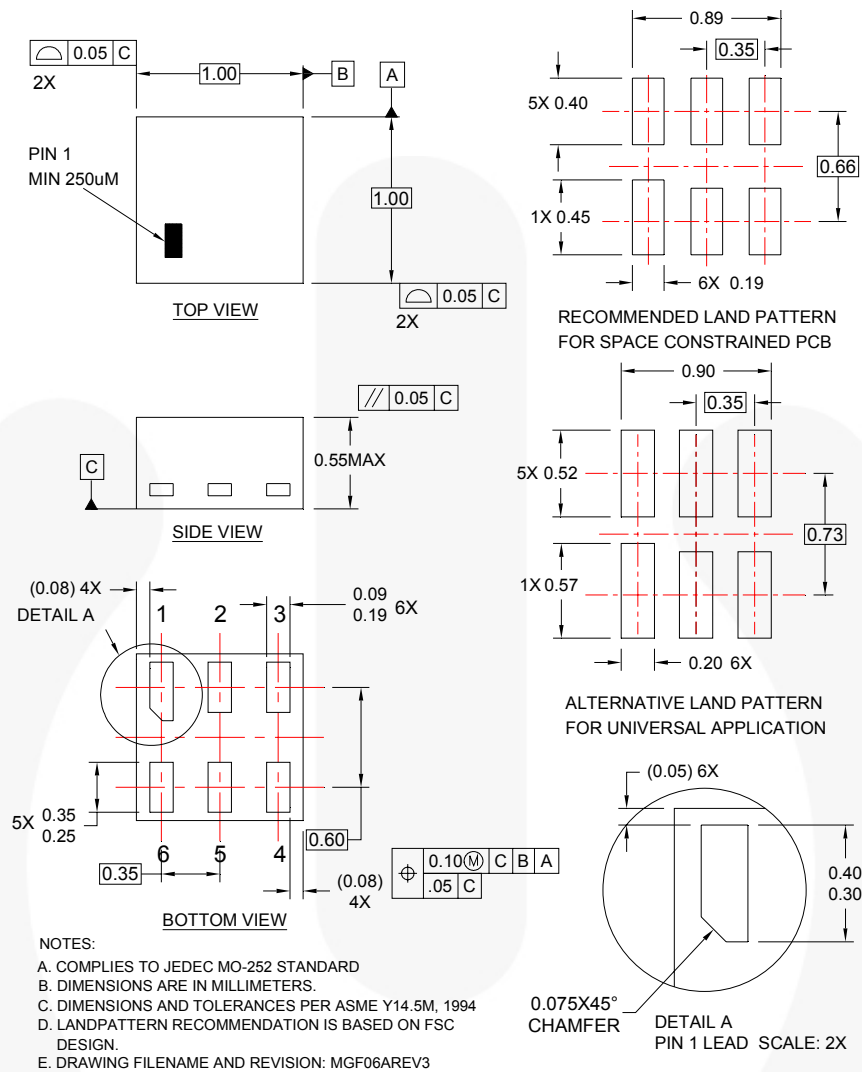


**Figure 10. AC Waveforms**

Symbol	$V_{CC}$					
	$3.3V \pm 0.3V$	$2.5V \pm 0.2V$	$1.8V \pm 0.15V$	$1.5V \pm 0.10V$	$1.2V \pm 0.10V$	$0.8V$
$V_{mi}$	$V_{CC}/2$	$V_{CC}/2$	$V_{CC}/2$	$V_{CC}/2$	$V_{CC}/2$	$V_{CC}/2$
$V_{mo}$	$V_{CC}/2$	$V_{CC}/2$	$V_{CC}/2$	$V_{CC}/2$	$V_{CC}/2$	$V_{CC}/2$



## Physical Dimensions



**Figure 12. 6-Lead, MicroPak2™, 1x1mm Body, .35mm Pitch**

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## Tape and Reel Specifications







Please visit Fairchild Semiconductor's online packaging area for the most recent tape and reel specifications:  
[http://www.fairchildsemi.com/packaging/MicroPAK2\\_6L\\_tr.pdf](http://www.fairchildsemi.com/packaging/MicroPAK2_6L_tr.pdf)

Package Designator	Tape Section	Cavity Number	Cavity Status	Cover Type Status
FHX	Leader (Start End)	125 (Typical)	Empty	Sealed
	Carrier	5000	Filled	Sealed
	Trailer (Hub End)	75 (Typical)	Empty	Sealed



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